	Hits	Search Text	DB	Time stamp
-	3269	waveguide.ti.	USPAT	2003/06/20 17:28
! _	214	(waveguide and (form\$5 or fabricat\$3)).ti.	USPAT	2003/06/10 12:26
l _	59	(waveguides and (form\$5 or	USPAT	2003/06/10 13:23
İ	3,		OBLAI	2003/00/10 13:23
:		fabricat\$3)).ti.		
-	1	(wave-guide and (form\$5 or	USPAT	2003/06/10 12:21
		fabricat\$3)).ti.		
-	455	(216/24).CCLS.	USPAT	2003/06/10 12:41
l <u>-</u>	53	((216/24).CCLS.) and (waveguide or	USPAT	2003/06/10 12:44
		waveguides).ti.	002111	2000,00,10 12011
<u>-</u>	221		HCDAM	2002/06/10 12:40
-	221	(438/31).CCLS.	USPAT	2003/06/10 12:49
-	123	(65/385).CCLS.	USPAT	2003/06/10 12:46
-	105	(65/386).CCLS.	USPAT	2003/06/18 14:33
<u>-</u>	172	(264/1.24).CCLS.	USPAT	2003/06/10 12:46
l _	303	(438/29).CCLS.	USPAT	2003/06/10 12:47
l. ⁻	1			· ·
	1164	(385/123).CCLS.	USPAT	2003/06/10 12:50
-	483	(385/124).CCLS.	USPAT	2003/06/10 12:50
-	279	(385/125).CCLS.	USPAT	2003/06/10 12:50
l <u>-</u>	358	(385/126).CCLS.	USPAT	2003/06/11 09:15
İ	404			•
-	Ł .	(385/127).CCLS.	USPAT	2003/06/10 12:52
-	426	(385/128).CCLS.	USPAT	2003/06/10 12:54
-	. 655	(385/129).CCLS.	USPAT	2003/06/11 12:55
-	720	(385/130).CCLS.	USPAT	2003/06/10 12:58
l _	562	(385/131).CCLS.	USPAT	2003/06/11 12:59
				1
_	446	(385/132).CCLS.	USPAT	2003/06/10 12:56
_	430	(385/142).CCLS.	USPAT	2003/06/10 12:57
-	. 240	(385/144).CCLS.	USPAT	2003/06/10 12:57
_	764	(385/141).CCLS.	USPAT .	2003/06/10 12:57
_	260	(385/143).CCLS.	USPAT	2003/06/10 12:58
_			i	I to the second
_	225	(385/146).CCLS.	USPAT	2003/06/10 12:58
-	270	((438/29).CCLS.) not ((438/31).CCLS.)	USPAT	2003/06/10 13:01
	142	((216/24).CCLS.) and (waveguide or	USPAT	2003/06/10 13:06
	1	wave-guide or waveguides)	1	
l _	1	("6571037").PN.	HEDAT	2003/06/10 12:27
	1 05		USPAT	2003/06/10 13:27
-	95	waveguide and ((material or materials)	USPAT	2003/06/10 15:08
		same (silicon or silica) same (InP or	1	
	1	GaInAsP) same (doped or glass))		
_	33	waveguide and core and cladding and	USPAT	2003/06/11 10:08
		((material or materials) same (silicon or	332.731	
				1
		silica) same (InP or GaInAsP) same (doped		
		or glass))	'	
-	18	(waveguide or waveguides).ti. and	USPAT	2003/06/10 14:54
		((silicon or silica) same (InP or GaInAsP)		
		same (doped))		
-	8	(waveguide or waveguides).ti. and (InP or	USPAT	2003/06/10 14:55
		GaInAsP) same (doped adj (silica or	1	
		glass))	1	
- :	54	waveguide and ((material or materials)	USPAT	2003/06/10 16:23
		same (silicon or silica) same (InP or	~~~~~	_555,55,15 10.25
•				
		GaInAsP) same (doped))		
-	58	waveguide.ti. and (silicon with substrate)	USPAT	2003/06/10 16:26
		and ((doped or doping) adj silica)		1 .
-	358	(385/126).CCLS.	USPAT	2003/06/11 09:16
_	99	((385/126).CCLS.) and (silica near5	USPAT	2003/06/11 09:18
	l		JOLAI	2000/00/11 09:18
		cladding)	1	
	447	((silica adj glass) with cladding)	USPAT	2003/06/11 09:34
- I	8	(((silica adj glass) with cladding)) and	USPAT	2003/06/11 09:19
-	٥		I	1
-		(216/24).ccls	i .	1
_	-		IISPAT	2003/06/11 00.40
- -	77	((silica adj glass) adj cladding)	USPAT	2003/06/11 09:40
- - -	-	((silica adj glass) adj cladding) ((silica adj glass) adj cladding) and	USPAT USPAT	2003/06/11 09:40 2003/06/11 09:40
- -	77 1	((silica adj glass) adj cladding) ((silica adj glass) adj cladding) and anneal\$3	ľ	2003/06/11 09:40
- - -	77	((silica adj glass) adj cladding) ((silica adj glass) adj cladding) and anneal\$3 ("3934061" "4820655" "5206925"	ľ	1
- - -	77 1	((silica adj glass) adj cladding) ((silica adj glass) adj cladding) and anneal\$3 ("3934061" "4820655" "5206925"	USPAT	2003/06/11 09:40
-	77 1	((silica adj glass) adj cladding) ((silica adj glass) adj cladding) and anneal\$3 ("3934061" "4820655" "5206925" "5253319" -"5295205" "5324678"	USPAT	2003/06/11 09:40
-	77 1	((silica adj glass) adj cladding) ((silica adj glass) adj cladding) and anneal\$3 ("3934061" "4820655" "5206925" "5253319" "5295205" "5324678" "5408569" "5637187" "5678935"	USPAT	2003/06/11 09:40
-	77 1	((silica adj glass) adj cladding) ((silica adj glass) adj cladding) and anneal\$3 ("3934061" "4820655" "5206925" "5253319" "5295205" "5324678" "5408569" "5637187" "5678935" "5703978" "5719973" "5732179"	USPAT	2003/06/11 09:40
-	77 1	((silica adj glass) adj cladding) ((silica adj glass) adj cladding) and anneal\$3 ("3934061" "4820655" "5206925" "5253319" "5295205" "5324678" "5408569" "5637187" "5678935" "5703978" "5719973" "5732179" "5783468" "5885881" "5904491"	USPAT	2003/06/11 09:40
-	77 1	((silica adj glass) adj cladding) ((silica adj glass) adj cladding) and anneal\$3 ("3934061" "4820655" "5206925" "5253319" "5295205" "5324678" "5408569" "5637187" "5678935" "5703978" "5719973" "5732179"	USPAT	2003/06/11 09:40
-	77 1	((silica adj glass) adj cladding) ((silica adj glass) adj cladding) and anneal\$3 ("3934061" "4820655" "5206925" "5253319" "5295205" "5324678" "5408569" "5637187" "5678935" "5703978" "5719973" "5732179" "5783468" "5885881" "5904491" "5982973" "6044192" "6122429"	USPAT	2003/06/11 09:40
-	77 1	((silica adj glass) adj cladding) ((silica adj glass) adj cladding) and anneal\$3 ("3934061" "4820655" "5206925" "5253319" "5295205" "5324678" "5408569" "5637187" "5678935" "5703978" "5719973" "5732179" "5783468" "5885881" "5904491" "5982973" "6044192" "6122429" "6177290" "6201918" "6208792"	USPAT	2003/06/11 09:40
-	77 1 23	((silica adj glass) adj cladding) ((silica adj glass) adj cladding) and anneal\$3 ("3934061" "4820655" "5206925" "5253319" "5295205" "5324678" "5408569" "5637187" "5678935" "5703978" "5719973" "5732179" "5783468" "5885881" "5904491" "5982973" "6044192" "6122429" "6177290" "6201918" "6208792" "6303393" "6317444").PN.	USPAT USPAT	2003/06/11 09:40 2003/06/11 09:55
-	77 1	((silica adj glass) adj cladding) ((silica adj glass) adj cladding) and anneal\$3 ("3934061" "4820655" "5206925" "5253319" "5295205" "5324678" "5408569" "5637187" "5678935" "5703978" "5719973" "5732179" "5783468" "5885881" "5904491" "5982973" "6044192" "6122429" "6177290" "6201918" "6208792"	USPAT	2003/06/11 09:40

-	206	((waveguide and core and cladding) not	USPAT	2003/06/11 10:49
		(fiber or fibre)) and (silica or glass or		
		quartz)		
-	26	((waveguide and core and cladding) not	USPAT	2003/06/11 10:27
		(fiber or fibre)) and (silica adj glass)		
-	10	((waveguide and core and cladding) not	USPAT	2003/06/11 10:12
		(fiber or fibre)) and ((silica adj glass)		
	31	with cladding) ((waveguide and core and cladding) not	USPAT	2003/06/11 10:32
		(fiber or fibre)) and (silica or glass or	USFAI	2003/00/11 10.32
		quartz) and anneal\$3		
_	33	((waveguide and core and cladding) not	USPAT	2003/06/11 10:27
	1	(fiber or fibre)) and ((silica adj glass)		
		or PSG or BPSG or silicate)		
-	35	((waveguide and core and cladding) not	USPAT	2003/06/11 10:33
		(fiber or fibre)) and (silica or glass or		
		quartz or polysilicon) and anneal\$3		0000/05/11 10 00
-	0	PSG with polysilican and glass	USPAT	2003/06/11 10:33
1_	398 207	PSG with polysilicon and glass PSG with polysilicon with glass	USPAT USPAT	2003/06/11 10:34 2003/06/11 10:34
-	20	((waveguide and core and cladding) not	USPAT	2003/06/11 10:49
1		(fiber or fibre)) and fused adj silica		= 555,50,11 10.15
-	299	(waveguide and (fabrication or fabricating	USPAT	2003/06/11 11:03
		or forming or making or formation)).ti.		<u> </u>
-	562	(385/131).CCLS.	USPAT	2003/06/11 13:01
-	446	(385/132).CCLS.	USPAT	2003/06/11 13:02
-	418	(()) ((USPAT	2003/06/18 11:29
-	221 12	(438/31).CCLS.	USPAT	2003/06/11 14:22
-	12	("4495412" "4606602" "4715672" "4776087" "4851025" "4901329"	USPAT	2003/06/11 15:15
1		"5002352" "5444805" "5518965"		_
		"5533156" "5565693" "5604835").PN.		
-	295	waveguide.ti. and (buffer adj layer)	USPAT	2003/06/11 14:46
-	42	waveguide.ti. and (buffer adj layer) and	USPAT	2003/06/11 14:46
		(anneal or annealing)		
-	448	(385/132).CCLS.	USPAT	2003/06/18 11:07
-	131	((385/132).CCLS.) and core and (clad or	USPAT	2003/06/18 11:08
		cladding) and (oxide or dioxide or silicon or "SiO.sub.2" or SiO2)		[
_	14	4652290.URPN.	USPAT	2003/06/18 11:19
_	327	waveguide.ti. and (channel or trench).clm.	USPAT	2003/06/18 11:23
_	8	("5054872" "5136682" "5142605"	USPAT	2003/06/18 11:28
		"5165004" "5170461" "5282078"		
		"5291574" "5352566").PN.		
-	420	((385/131).CCLS.) not ((385/132).CCLS.)	USPAT	2003/06/18 11:48
	142	((216/24).CCLS.) and (waveguide or ((wave	USPAT	2003/06/18 12:01
_	2	or light) adj guide)) ("4919749" "5308442").PN.	HCDAM	2002/06/10 11 55
_	0	("4919749" "5308442").PN.	USPAT USPAT	2003/06/18 11:55
-	. ŏ	5431775.URPN.	USPAT	2003/06/18 11:55
_	5689	(waveguide or ((wave or light) adj guide))	USPAT;	2003/06/18 12:06
		and etch\$3 and ((silicon adj (oxide or	US-PGPUB;	, 50, 40 12.00
		dioxide)) or "SiO.sub.2" or SiO2)	EPO; JPO;	
		,	DERWENT;	
	010		IBM_TDB	0000405455
_	818	(waveguide or ((wave or light) adj	USPAT;	2003/06/18 12:15
		<pre>guide)).ti. and etch\$3 and ((silicon adj (oxide or dioxide)) or "SiO.sub.2" or</pre>	US-PGPUB; EPO; JPO;	
	i	SiO2)	DERWENT;	
		<u>:</u>	IBM TDB	
-	157	((waveguide or ((wave or light) adj	USPAT;	2003/06/18 12:15
į		guide)).ti. and etch\$3 and ((silicon adj	US-PGPUB;	
		(oxide or dioxide)) or "SiO.sub.2" or	EPO; JPO;	
1		SiO2)) and core and clad\$3	DERWENT;	
<u> </u>	,	Marana da an Marana an 21 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	IBM_TDB	0000/05/55
-	7	((waveguide or ((wave or light) adj	JPO	2003/06/18 12:15
		<pre>guide)).ti. and etch\$3 and ((silicon adj (oxide or dioxide)) or "SiO.sub.2" or</pre>		
		SiO2)) and core and clad\$3		
		TITE,, and COLO and Cladys		

-	28	((waveguide or ((wave or light) adj guide)).ti. and etch\$3 and ((silicon adj	JPO	2003/06/18 12:15
		(oxide or dioxide)) or "SiO.sub.2" or		
	20	SiO2))	770	0000100110 10 10
-	20	(waveguide or ((wave or light) adj quide)).ti. and silicon and (channel or	EPO; JPO	2003/06/18 12:19
		trench)		
-	60	,	EPO; JPO USPAT;	2003/06/18 12:20 2003/06/18 12:21
			US-PGPUB	
-	123	(photodiode).ti. and silicon and (oxide or dioxide) and etch\$3	USPAT; US-PGPUB	2003/06/18 12:22
_	44	The state of the s	USPAT;	2003/06/18 12:23
	8	dioxide) and (etch\$3 or remov\$3).clm. 3980461.URPN.	US-PGPUB	2002/06/10 14 20
-	11		USPAT USPAT	2003/06/18 14:28 2003/06/18 14:29
		"3278283" "3455667" "3455668"		
		"3542535" "3647406" "3771983" "3879182" "3926601").PN.		
- '	19370	(silicon adj (nitride and oxide)) and	USPAT;	2003/06/19 12:39
	·	mask\$3 and etch\$3	US-PGPUB; EPO; JPO;	
			DERWENT;	
_	. 1341	((silicon adj (nitride and oxide)) and	IBM_TDB USPAT;	2003/06/19 11:52
	. 1541	mask\$3 and etch\$3).ab.	US-PGPUB;	2003/00/19 11.32
			EPO; JPO;	
			DERWENT; IBM TDB	
-	49	((), (USPAT;	2003/06/19 11:52
	ļ	(hard adj mask\$3) and etch\$3).ab.	US-PGPUB; EPO; JPO;	
			DERWENT;	
<u>-</u>	, 556	((silicon adj (nitride and oxide)) and	IBM_TDB USPAT;	2003/06/19 11:57
		mask\$3 and etch\$3) and (waveguide or	US-PGPUB;	2003,00,13,11.3,
		(light adj guide))	EPO; JPO; DERWENT;	
			IBM_TDB	
-	532	(((silicon adj (nitride and oxide)) and mask\$3 and etch\$3) and (waveguide or	USPAT; US-PGPUB;	2003/06/19 12:06
		(light adj guide))) and (trench or groove	EPO; JPO;	
		or channel or cavity or via or opening or gap or void or ditch or street or trough	DERWENT; IBM TDB	
		or furrow)	_	
-	106			2003/06/19 12:00
		mask\$3 and etch\$3) and (waveguide or (light adj guide))) and (trench or groove	US-PGPUB; EPO; JPO;	
		or channel or cavity or via or opening or	DERWENT;	
		gap or void or ditch or street or trough or furrow)) and (core and clad\$4)	IBM_TDB	
-	60	(silicon adj (nitride and oxide)) and	USPAT;	2003/06/19 12:31
		mask\$3 and etch\$3 and (SOI or silicon-on-insulator) and etch-stop	US-PGPUB; EPO; JPO;	
		3333	DERWENT;	
_	55	(silicon adj (nitride and oxide)) and	IBM_TDB USPAT;	2003/06/19 12:31
		mask\$3 and etch\$3 and (SOI or	US-PGPUB;	2005,00,15 12.51
		silicon-on-insulator) and waveguide	EPO; JPO; DERWENT;	
			IBM_TDB	·
-	1588	(silicon adj (nitride and oxide)) and (hard adj mask\$3) and etch\$3	USPAT;	2003/06/19 12:41
		(Mara ad) maskys/ and econys	US-PGPUB; EPO; JPO;	
			DERWENT;	
-	40	(silicon adj (nitride and oxide)) and	IBM_TDB USPAT;	2003/06/19 14:59
		(hard adj mask\$3) and (etch\$3 with trench)	US-PGPUB;	
		and (waveguide or diode)	EPO; JPO; DERWENT;	
			IBM_TDB	

- 634 (silicon adj (nitride and oxide)) and (hard adj mask\$3) and (etch\$3 with trench) - 46 (trench and waveguide\$1).ti. - 243 (trench and waveguide\$1).ab. - 243 (trench and waveguide\$1).ab. - 1 1993-314383.NRAN. - 254 core and clad\$4 and etch\$3 and waveguide and silicon and (refractive adj index) - 254 core and clad\$4 and etch\$3 and waveguide and clad\$4 and etch\$5 and waveguide and clad\$4 and etch\$5 and waveguide and clad\$4 and etch\$5 and waveguide and clad\$4 and etch\$5 and waveguide and clad\$4 and etch\$5 and waveguide and clad\$4 and etch\$5 and waveguide and clad\$4 and etch\$5 and waveguide and clad\$4 and etch\$5 and waveguide and clad\$4 and etch\$5 and waveguide and clad\$4 and etch\$5 and waveguide and clad\$4 and etch\$5 and waveguide and clad\$4 and etch\$6 and waveguide and clad\$4 and etch\$6 and waveguide and clad\$4 and etch\$6 and waveguide an	9 13:09 9 13:09 9 17:03
EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT 2003/06/19 and silicon and (refractive adj index) uspat 2003/06/19 2003/0	9 13:09 9 17:03
DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19	9 13:09 9 17:03
TBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB DERWENT 2003/06/19 200	9 13:09 9 17:03
- 46 (trench and waveguide\$1).ti. USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT USPAT 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19	9 13:09 9 17:03
US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT USPAT 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19	9 13:09 9 17:03
EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT 2003/06/19 and silicon and (refractive adj index) - 254 core and clad\$4 and etch\$3 and waveguide and silicon and (refractive adj index) USPAT 2003/06/19	9 17:03
DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT; US-PGPUB; EPO; JPO; DERWENT; USPAT 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19	9 17:03
- 243 (trench and waveguide\$1).ab. IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB DERWENT; IBM_TDB DERWENT 2003/06/19	9 17:03
- 243 (trench and waveguide\$1).ab. USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB DERWENT 2003/06/19 - 1 1993-314383.NRAN. DERWENT 2003/06/19 - 876 core and clad\$4 and etch\$3 and waveguide and silicon and (refractive adj index) - 254 core and clad\$4 and etch\$3 and USPAT 2003/06/19	9 17:03
US-PGPUB; EPO; JPO; DERWENT; IBM_TDB DERWENT 2003/06/19 1 1993-314383.NRAN. DERWENT 2003/06/19 2 ore and clad\$4 and etch\$3 and waveguide and silicon and (refractive adj index) 2 core and clad\$4 and etch\$3 and USPAT 2003/06/19	9 17:03
EPO; JPO; DERWENT; IBM_TDB 1 1993-314383.NRAN. 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19 2003/06/19	
DERWENT; IBM_TDB DERWENT; DERWENT DERWENT DERWE	
1 1993-314383.NRAN. IBM_TDB DERWENT 2003/06/19	
- 1 1993-314383.NRAN. DERWENT 2003/06/19 876 core and clad\$4 and etch\$3 and waveguide and silicon and (refractive adj index) - 254 core and clad\$4 and etch\$3 and USPAT 2003/06/19	
- 876 core and clad\$4 and etch\$3 and waveguide uSPAT 2003/06/19 and silicon and (refractive adj index) - 254 core and clad\$4 and etch\$3 and USPAT 2003/06/19	
and silicon and (refractive adj index) core and clad\$4 and etch\$3 and USPAT 2003/06/19	9 18:08
- 254 core and clad\$4 and etch\$3 and USPAT 2003/06/19	
l lorge model at and atlians and functions	3 18:11
waveguide.ti. and silicon and (refractive	
adj index)	
- 535 core and clad\$4 and etch\$3 and waveguide USPAT 2003/06/19	3 18:11
and dop\$3 and silicon and (refractive adj	
index)	
- 146 core and clad\$4 and etch\$3 and USPAT 2003/06/19	3 18:18
waveguide.ti. and dop\$3 and silicon and	
(refractive adj index)	
- 73 ((first and second) adj clad\$3) same USPAT 2003/06/19	3 18:27
(refractive adj index)	
- 3 ((top and bottom) adj clad\$3) same USPAT 2003/06/19	3 18:20
(refractive adj index)	
- 89 ((clad\$3) with (refractive adj index) with USPAT 2003/06/19	18:29
((first and second) or (top and bottom)))	
and waveguide	
- 11 waveguide and ((CMP or (chemical adj USPAT 2003/06/20	16:36
mechanical adj polishing)) same core)	
- 2 waveguide and (trench with etch\$3 with USPAT 2003/06/20	17:31
(silicon-on-insulator or SOI))	
- 4 waveguide and (trench same etch\$3 same USPAT 2003/06/20	17:33
(silicon-on-insulator or SOI))	
- 398 (trench same etch\$3 same USPAT 2003/06/20	17:34
(silicon-on-insulator or SOI))	. 11.01